







## **Model Curriculum**

**QP Name: Laser Marking and Cutting - Process Supervisor** 

QP Code: ELE/Q0118

QP Version: 3.0

**NSQF Level: 5** 

**Model Curriculum Version: 3.0** 

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## **Training Parameters**

Sector	Electronics
Sub-Sector	Semiconductor & Components
Occupation	Production - S&C
Country	India
NSQF Level	5
Aligned to NCO/ISCO/ISIC Code	NCO-2015/3119.1100
Minimum Educational Qualification and Experience	Completed 2nd year of UG (UG Diploma) (Physics/ Electronics/ Electrical/Mechanical) with 1.5 years of Relevant Experience OR Completed 3 year diploma after 10th (Electronics/Electrical/ Mechanical) with 3 Years of Relevant Experience OR Previous relevant Qualification of NSQF Level (4.5) with 1.5 years of Relevant Experience #Relevant Experience in Semiconductor & Components
Pre-Requisite License or Training	NA
Minimum Job Entry Age	18 Years
Last Reviewed On	01.05.2025
Next Review Date	31.10.2025
NSQC Approval Date	08.05.2025
QP Version	3.0
Model Curriculum Creation Date	01.05.2025
Model Curriculum Valid Up to Date	31.10.2025
Model Curriculum Version	3.0
Minimum Duration of the Course	570 Hours
Maximum Duration of the Course	570 Hours







### **Program Overview**

This section summarizes the end objectives of the program along with its duration.

#### **Training Outcomes**

At the end of the program, the learner should have acquired the listed knowledge and skills:

- Describe the process of Semiconductor Manufacturing, Assembly, Testing & Packaging evaluating customer requirements and computer issues.
- Demonstrate the evaluation process of customer requirements and semiconductors processing.
- Demonstrate the operations and uses of machineries used for Laser Marking & Cutting.
- Demonstrate the process of carrying out repair and maintenance of a laptop and its peripherals.
- Demonstrate various practices to be followed to maintain health and safety at work.

#### **Compulsory Modules**

The table lists the modules and their duration corresponding to the Compulsory NOS of the QP.

NOS and Module Details	Theory Duration	Practical Duration	On-the-Job Training Duration (Mandatory)	On-the-Job Training Duration (Recommended)	Total Duration
ELE/N0117: Recipe/ Program Readiness - Define Process Parameters	66:00	54:00	30:00	00:00	150:00
Module 1: Recipes/Program readiness (Define Process Parameters)	66:00	54:00	30:00	00:00	150:00
ELE/N0118: Data Analysis and Yield, Cost & Productivity Improvement	30:00	60:00	30:00	00:00	120:00
Module 2: Process of Data Analysis & Yield, Cost & Productivity Improvement	30:00	60:00	30:00	00:00	120:00
ELE/N0119: Equipment Setup support	30:00	30:00	60:00	00:00	120:00
Module 3:Process of Equipment Set Up Support	30:00	30:00	60:00	00:00	120:00
ELE/N0120: Provision for Machine/Tools Buy Off	30:00	30:00	60:00	00:00	120:00
Module 4: Buy off Machine & Tools	30:00	30:00	60:00	00:00	120:00







DGT/VSQ/N0102: Employability Skills (60 Hours)	24:00	36:00	00:00	00:00	60:00
Module 5: Employability Skills (60 Hours)	24:00	36:00	00:00	00:00	60:00
<b>Total Duration</b>	180:00	210:00	180:00	00:00	570:00







### **Module Details**

## Module 1: Recipes/Program Readiness (Define Process Parameters) Mapped to ELE/N0117

#### **Terminal Outcomes:**

• State the role and responsibilities of a Laser Marking & Cutting - Process Engineer.

Duration: 66:00	Duration: 54:00		
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes		
<ul> <li>Describe the strip dimensions &amp; internal structure</li> <li>Discuss the package outline drawing</li> </ul>	<ul> <li>Do measurement of laser depth, marking content size &amp; visibility check</li> </ul>		
& Strip Drawing	Run Dummy sample and calculate		
<ul> <li>Describe how to verify process parameters</li> </ul>	CPK, PPK & Other quality		
<ul> <li>Preparation of SOP &amp; Travelling Card</li> </ul>			
Classroom Aids			
Training kit - Trainer guide, Presentations, Whitel	ooard, Marker, projector, laptop		
Tools, Equipment and Other Requirements			
Tools and Equipment's related to Laser Marking 8	& Cutting Process		







## Module 2: Data Analysis & Yield, Cost & Productivity Improvement *Mapped to ELE/N0118*

#### **Terminal Outcomes:**

- Describe the process of Improvements for Product Quality by defining parameters.
- Demonstrate the process of Yield Tracking & Improvement.
- Demonstrate the process of cost and Productivity Improvement.

Duration: 30:00	Duration: 60:00		
heory – Key Learning Outcomes	Practical – Key Learning Outcomes		
<ul> <li>Describe the process of improvements for product quality by defining parameters.</li> </ul>	<ul> <li>Demonstrate the use of relevant tools and equipment for the Die Attach Process.</li> </ul>		
<ul> <li>Describe the process of Yield Tracking &amp; Improvement.</li> </ul>	<ul> <li>Demonstrate the process of Wire Bonding Process.</li> </ul>		
<ul> <li>Describe the process of Cost and productivity Improvement.</li> </ul>	Demonstrate the process of installing different types of computer OS and		
<ul> <li>Describe all the die dimensions, Stacking Combinations &amp; wire bonding parameters.</li> </ul>	<ul> <li>software.</li> <li>Demonstrate the process of testing for the correct functioning.</li> </ul>		
<ul> <li>Describe the design of Experiments (DOE) Expertise.</li> </ul>	<ul> <li>Show how to carry out troubleshooting for the common</li> </ul>		
<ul> <li>Description on Understanding of working principal of machines to improve UPH.</li> </ul>	issues identified after verification of Parameters.		
Classroom Aids			

#### **Tools, Equipment and Other Requirements**

Semiconductor Component Manufacturing Tools & Equipment's







# Module 3: Equipment Set Up Support *Mapped to ELE/N0119*

#### **Terminal Outcomes:**

- Awareness of Design Creation and Review
- Understanding of Stacking structure and Design Verification.

Duration: 30:00	Duration: 30:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
<ul> <li>Support loader/unloader &amp; rail setup</li> <li>Material Handling Procedure Support</li> <li>Laser Set Up Support</li> <li>Changeover         Material Handling Procedure         Support</li> <li>Laser Setup         Setup         Support changeover</li> <li>Description handling steps of magazine and strips during marking</li> </ul>	<ul> <li>Define strip location and orientation for correct marking</li> <li>Check all marking parameters weather they are ok or Not</li> <li>Keep the records of all abnormalities (False Alarm, stoppage, mis marking etc.) happened through the day</li> </ul>
Classroom Aids	
Training kit (Trainer guide, Presentations)	
Tools, Equipment and Other Requirements	







# Module 4: Buy Off Machines & Tools *Mapped to ELE/N0120*

#### **Terminal Outcomes:**

- Describe & complete the process of Factory Acceptance test at Equipment Manufacturing Site.
- Demonstrate & complete the process of site acceptance test at product manufacturer site

Duration: 30:00	Duration: 30:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
<ul> <li>List of Machines &amp; Tools required for process of Laser Marking &amp; Cutting</li> <li>FAT Report Creation</li> <li>Awareness on general Machine Specification like Operation, Controller, Panel etc</li> <li>Knowledge of characterization phase, feasibility phase, customer samples phase and qualification phase is must</li> <li>Collection of all the quality and realibity data for each characterization, feasibility and qualification build</li> </ul>	<ul> <li>Demonstrate the generation of PCN</li> <li>Process of preparation of Solid Reports</li> <li>Description on All equipment consumables specifications, dimensions and other parameters should be clearly defined by process and equipment engineer</li> </ul>
Classroom Aids	
Training kit (Trainer guide, Presentations)	
Tools, Equipment and Other Requirements	
Information on all Equipment's & Tools	







# Module 5: Employability Skills (60 Hours) Mapped to DGT/VSQ/N0102

#### **Terminal Outcomes:**

- Discuss about Employability Skills in meeting the job requirements
- Describe opportunities as an entrepreneur.
- Describe ways of preparing for apprenticeship & Jobs appropriately.

Duration: 24:00	<b>Duration:</b> 36:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
<ul> <li>Explain constitutional values, civic rights, responsibility towards society to become a responsible citizen</li> </ul>	<ul> <li>List different learning and employability related GOI and private portals and their usage</li> </ul>
<ul> <li>Discuss 21<sup>st</sup> century skills</li> <li>Explain use of basic English phrases and sentences.</li> </ul>	<ul> <li>Show how to practice different environmentally sustainable practices.</li> </ul>
<ul> <li>Demonstrate how to communicate in a well-behaved manner</li> </ul>	<ul> <li>Exhibit 21st century skills like Self- Awareness, Behavior Skills, time management, etc.</li> </ul>
Demonstrate how to work with others	<ul> <li>Show how to use basic English sentences for everyday conversation</li> </ul>
<ul> <li>Demonstrate how to operate digital devices</li> </ul>	<ul> <li>in different contexts, in person and over the telephone</li> <li>Demonstrate how to communicate in</li> </ul>
<ul> <li>Discuss the significance of Internet and Computer/ Laptops</li> </ul>	a well -mannered way with others.
<ul> <li>Discuss the need for identifying business opportunities</li> </ul>	Demonstrate how to communicate effectively using verbal and nonverbal
<ul> <li>Discuss about types of customers.</li> </ul>	communication etiquette
Discuss on creation of biodata	<ul> <li>Utilize virtual collaboration tools to workeffectively</li> </ul>
<ul> <li>Discuss about apprenticeship and opportunities related to it.</li> </ul>	<ul> <li>Demonstrate how to maintain hygiene and dressing appropriately.</li> </ul>
	Perform a mock interview

#### **Classroom Aids**

Training Kit (Trainer Guide, Presentations). Whiteboard, Marker, Projector, Laptop

#### **Tools, Equipment and Other Requirements**

Computer, UPS, Scanner, Computer Tables, LCD Projector, Computer Chairs, White Board OR

Computer Lab







## Module 6: On-the-Job Training Mapped to Laser Marking and Cutting - Process Supervisor

Mandatory Duration: 180:00 Recommended Duration: 00:00

**Location: On Site** 

#### **Terminal Outcomes**

1. Explain the functions of a Laser Marking & Cutting Machine.

- 2. List the preliminary tasks involved in the repair and maintenance of a Laser Marking & Cutting machines and its tools.
- 3. Demonstrate how to perform preliminary checks on a machines & tools.
- 4. Perform steps to inspect the Laser Marking Machines to identify defective modules/components.
- 5. Perform repair and maintenance activities as per the Service Level Agreement (SLA).
- 6. Perform steps to test the functioning of machineries after manufacturing process.
- 7. Communicate product and service-related information to the customer.
- 8. Employ appropriate practices to interact and coordinate with supervisor and colleagues.
- 9. Perform assigned work within the turnaround time and as per the defined quality standards.
- 10. Demonstrate how to maintain a healthy, safe and secure working environment.







### **Annexure**

### **Trainer Requirements**

Trainer Prerequisites							
Minimum Educational	Specialization	Relevant Industry Experience		Trainin	g Experience	Remarks	
Qualification		Years	Specialization	Years	Specialization		
Diploma/ Degree/ ITI/ Certified in relevant CITS Trade	(Electrical/Electronics/ Mechanical)	2	Laser Marking  – Assembly & Packaging	1	Electronics		

Trainer Certification						
Domain Certification Platform Certification						
"Laser Marking and Cutting - Process Supervisor, ELE/Q0118, version 3.0". Minimum accepted score is 80%.	Recommended that the Trainer is certified for the Laser Laser Marking and Cutting - Process Supervisor "Trainer (VET and Skills)", mapped to the Qualification Pack: "MEP/Q2601, V2.0", with minimum score of 80%					







### **Assessor Requirements**

Assessor Prerequisites							
Minimum Educational	Specialization	Relevant Industry Experience		Trainin Experie	g/Assessment ence	Remarks	
Qualification		Years	Specialization	Years	Specialization		
Diploma/ Degree/ ITI/ Certified in relevant CITS Trade	(Electrical/Electronics/ Mechanical)	3	Laser Marking  – Assembly & Packaging	1	Electronics		

Assessor Certification					
Domain Certification	Platform Certification				
"Laser Marking and Cutting - Process Supervisor, ELE/Q0118, version 3.0". Minimum accepted score is 80%.	Recommended that the Assessor is certified for the Laser Marking and Cutting - Process Supervisor "Assessor (VET and Skills)", mapped to the Qualification Pack: "MEP/Q2701, V2.0", with minimum score of 80%				







#### **Assessment Strategy**

- 1. Assessment System Overview:
  - Batches assigned to the assessment agencies for conducting the assessment on SDMS/SIP or email
  - Assessment agencies send the assessment confirmation to VTP/TC looping SSC
  - The assessment agency deploys the ToA certified Assessor for executing the assessment
  - SSC monitors the assessment process & records
- 2. Testing Environment

To ensure a conducive environment for conducting a test, the trainer will:

- Confirm that the centre is available at the same address as mentioned on SDMS or SIP
- Check the duration of the training.
- Check the Assessment Start and End time to be 10 a.m. and 5 p.m. respectively
- Ensure there are 2 Assessors if the batch size is more than 30.
- Check that the allotted time to the candidates to complete Theory & Practical Assessment is correct.
- Check the mode of assessment—Online (TAB/Computer) or Offline (OMR/PP).
- Confirm the number of TABs on the ground are correct to execute the Assessment smoothly.
- Check the availability of the Lab Equipment for the particular Job Role.
- 3. Assessment Quality Assurance levels / Framework:
  - Question papers created by the Subject Matter Experts (SME)
  - Question papers created by the SME verified by the other subject Matter Experts
  - Questions are mapped with NOS and PC
  - Question papers are prepared considering that level 1 to 3 are for the unskilled & semiskilled individuals, and level 4 and above are for the skilled, supervisor & higher management
  - The assessor must be ToA certified and the trainer must be ToT Certified
  - The assessment agency must follow the assessment guidelines to conduct the assessment
- 4. Types of evidence or evidence-gathering protocol:
  - Time-stamped & geotagged reporting of the assessor from assessment location
  - Centre photographs with signboards and scheme-specific branding
  - Biometric or manual attendance sheet (stamped by TP) of the trainees during the training period
  - Time-stamped & geotagged assessment (Theory + Viva + Practical) photographs & videos
- 5. Method of verification or validation:

To verify the details submitted by the training centre, the assessor will undertake:

- A surprise visit to the assessment location
- A random audit of the batch
- A random audit of any candidate
- 6. Method for assessment documentation, archiving, and access

To protect the assessment papers and information, the assessor will ensure:

- Hard copies of the documents are stored
- Soft copies of the documents & photographs of the assessment are uploaded / accessed from Cloud Storage







•	Soft copies of t	the documents &	k photograph	s of the asses	ssment are store	d on the Hard
	drive					







## **References**

#### Glossary

Term	Description	
Declarative knowledge	Declarative knowledge refers to facts, concepts and principles that need to be known and/or understood in order to accomplish a task or to solve a problem.	
Key Learning	Key learning outcome is the statement of what a learner needs to know, understand and be able to do in order to achieve the terminal outcomes. set of key learning outcomes will make up the training outcomes. Training outcome is specified in terms of knowledge, understanding (theory) and skills (practical application).	
OJT (M)	On-the-job training (Mandatory); trainees are mandated to complete specified hours of training on site	
OJT (R)	On-the-job training (Recommended); trainees are recommended the specified hours of training on site	
Procedural Knowledge	Procedural knowledge addresses how to do something, or how to perform a	
Training Outcome	Training outcome is a statement of what a learner will know, understand and be able to do <b>upon the completion of the training</b> .	
Terminal Outcome	Terminal outcome is a statement of what a learner will know, understand and be able to do <b>upon the completion of a module.</b> A set of terminal outcomes help to achieve the training outcome.	







Term	Description		
DC	Direct Current		
ISO	International Organization for Standardization		
NCO	National Occupational Standards		
NOS	National Skills Qualification Committee		
NSQF	National Skills Qualification Framework		
OJT	On-the-Job Training		
OMR	Optical Mark Recognition		
PC	Performance Criteria		
PwD	Persons with Disabilities		
QP	Qualification Pack		
SDMS	Skill Development & Management System		
SIP	Skill India Portal		
SME	Small and Medium Enterprises		
SOP	Standard Operating Procedure		
SSC	Sector Skill Council		
TC	Trainer Certificate		
ToA	Training of Assessors		
ТоТ	Training of Trainers		
ТР	Training Provider		